



LE71SDKZTAP Support Package P1.8.2

Jan 3, 2012

This document describes new features, fixed errata, and known errata for the LE71SDKZTAP Support Package, Version P1.8.2.

1.0 REVISION SUMMARY

This is a feature upgrade and bug fix to revision P1.6.1 of the LE71SDKZTAP support package. This release replaces all previous releases. This release requires the Microsemi Voice Toolkit (LE71SDKTK) P1.5.0 to make use of the new features listed below.

The contents of this release include the following:

- ZTAP Linux File System P1.8.2 (ztap_rootfs_1.8.2.jffs2)
- ZTAP Linux Kernel 2.6.22.19-4.04-z1 (ztap_kernel_2.6.22.19-4.04.0-z1.bin)
- ZTAP Media Stream Processor firmware 6.11.3 (ztap_msp_6.11.3.axf)
- FTDI USB to serial UART Windows driver installer (CDM20600.exe)

2.0 FILESYSTEM CONTENTS

- Includes New VP-API II P2.19.0 release
- Includes VE880 VeriVoice Professional (LE880SLVVP) P1.7.2 release
- Includes VE880 VeriVoice Auditor (LE880SLVV) P1.3.1 release
- Includes VE890 VeriVoice Professional (LE890SLVVP) P1.3.1 release
- Includes VE890 VeriVoice Auditor (LE890SLVV) P1.1.1 release
- Includes New VCP2-VP792 (LE79124SLxx) P2.7.0 release
- Includes VCP2-VP792 (LE79124SLTHM) P2.4.1 release
- Includes New VCP2-VP790 (LE79114SLxx) P1.2.5 release
- Includes New NGCC SLAC (LE71SK7920xx) P2.6.4 release + new firmware image
- Includes VCP-790 (LE79112SLxx) P1.10.2_P8 release
- Includes VCP2-VP792 128-channel (LE79128SLxx) P2.7.3 release

3.0 NEW FEATURES AND IMPROVEMENTS TO 1.6.1

3.1 PBX APPLICATION

C1 **New:** Default Caller Id Name has been changed to "Microsemi ZTAP"



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